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Dimensions	
Chip Size	0603
L	1.6mm +/-0.15mm
W	0.8mm +/-0.15mm
T	0.8mm +/-0.10mm
S	0.7mm MIN
B	0.35mm +/-0.15mm

Packaging Specifications	
Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

General Information	
Series	CAN SMD Indust 250
Style	SMD Chip
Description	SMD Chip, MLCC, AC Rated
Features	Temperature Stable, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	4.6 mg
MSL	1

Specifications	
Capacitance	680 pF
Measurement Condition	1 MHz 1.0Vrms
Capacitance Tolerance	5%
Voltage AC	250 VAC
Dielectric Withstanding Voltage	945 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1MHz 1.0Vrms
Dissipation Factor	0.1% 1MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	10 GOhms